

DATASHEET

SMD Side View LEDs 99-218GLM2C/L7785S7W/TR8-T



Features

- . Side view white LED.
- White SMT package.
- . Lead frame package with individual 2 pins.
- . Wide viewing angle
- . Soldering methods: IR reflow soldering
- . Pb-free
- . The product itself will remain within RoHS compliant version.
- . Compliance with EU REACH.
- . Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Descriptions

. Due to the package design, 99-218G has wide viewing angle, low power consumption and white LEDs are devices that are materialized by combing blue chips and special phosphor. This feature makes the LED ideal for light guide application.

Applications

- . LCD Backlight
- . Mobile Phones
- . Indicators
- . Illuminations
- . Switch Light

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Issue No: DSE-0018145

www.everlight.com

Ver.:4 Release Date:12/16/2021 狀態:Approved(正式發行)



Coding:

99-218GLM2C/LXX XX XX X /TR8-T



Device Selection Guide

Chip	Emitted Color	Resin Color	
Materials	Limited Goldi	resili odioi	
InGaN	Pure White	Water Clear	

Absolute Maximum Ratings (Ta=25°C)			
Parameter	Symbol	Rating	Unit
Reverse Voltage	V_{R}	5	V
Forward Current	l _F	30	mA
Peak Forward Current (Duty 1/10 @10ms)	I _{FP}	60	mA
Power Dissipation	P_d	90	mW
Operating Temperature	T_{opr}	-40 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +90	°C
Soldering Temperature	T_{sol}	Reflow Soldering : 260 °C Hand Soldering : 350 °C	

Notes: The products are sensitive to static electricity and must be carefully taken when handling products.

Electro-Optical Characteristics (Ta=25°C)

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Flux	Φ	7.75		8.75	lm	_
Viewing Angle	2θ 1/2		120		deg	IF=20mA
Forward Voltage	V_{F}	2.70		3.00	V	-
Reverse Current	IR			1	μА	V _R =5V

Notes:

1. Tolerance of Luminous Flux: ± 7%

2. Tolerance of Forward Voltage: ± 0.05V



Issue No: DSE-0018145



Bin Range of Luminous Flux

Bin Code	lm(Min.)	lm(Max.)	Unit	Condition	mcd(Min.)	mcd(Max.)
L77	7.75	8.00	· Im		2775	2865
L80	8.00	8.25		I==20 m A	2865	2955
L82	8.25	8.50		IF=20mA	2955	3045
L85	8.50	8.75			3045	3135

Note: Tolerance of Luminous Flux 、Luminous Intensity: ± 7%

Bin Range of Forward Voltage

Group	Bin Code	Min.	Max.	Unit	Condition
	4-2-3	2.70	2.80		
W	5-1-3	2.80	2.90	Volt	I _F =20mA
	5-2-3	2.90	3.00		

Note: Tolerance of Forward Voltage: ± 0.05V.



Chromaticity Coordinates of Bin Code

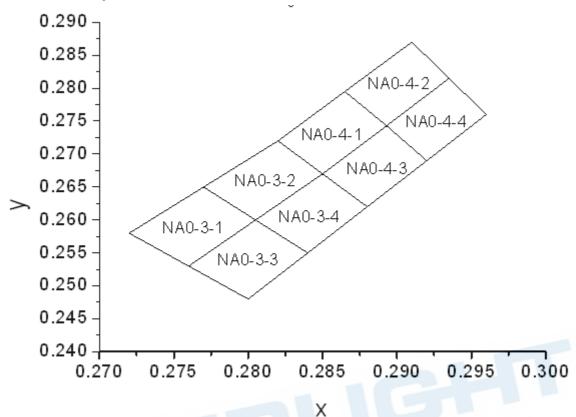
Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
_	0.2760	0.2530	_	0.2805	0.2600
NA0-3-1	0.2720	0.2580	- NA0-3-2 -	0.2770	0.2650
11/40-3-1	0.2770	0.2650	NAU-3-2	0.2820	0.2720
	0.2805	0.2600		0.2850	0.2670
	0.2800	0.2480	_	0.2840	0.2550
NA0-3-3	0.2760	0.2530	- NA0-3-4 -	0.2805	0.2600
NAU-3-3	0.2805	0.2600	NAU-3-4	0.2850	0.2670
	0.2840	0.2550		0.2880	0.2620
_	0.2850	0.2670	_	0.2893	0.2743
NA0-4-1	0.2820	0.2720	- NA0-4-2	0.2865	0.2795
NAU-4-1	0.2865	0.2795	NAU-4-2	0.2910	0.2870
	0.2893	0.2743		0.2935	0.2815
	0.2880	0.2620		0.2920	0.2690
NA0-4-3	0.2850	0.2670	NA0-4-4	0.2893	0.2743
	0.2893	0.2743	INAU-4-4	0.2935	0.2815
	0.2920	0.2690		0.2960	0.2760

Note: Tolerance of Chromaticity Coordinates: ±0.005.

Issue No: DSE-0018145

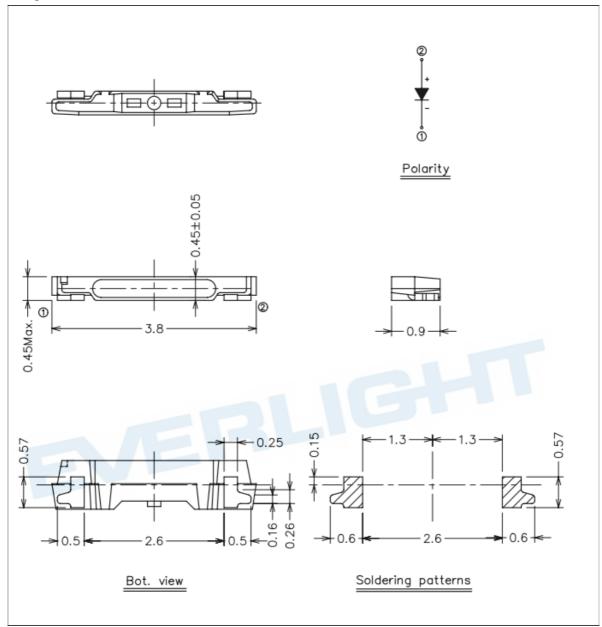


Chromaticity Coordinates of Bin Code





Package Outline Dimensions

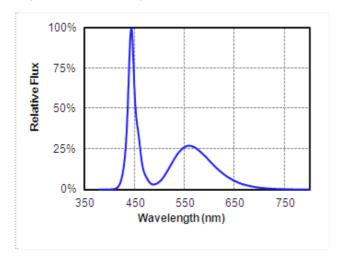


Note: The tolerances unless dimensions are ± 0.1mm.

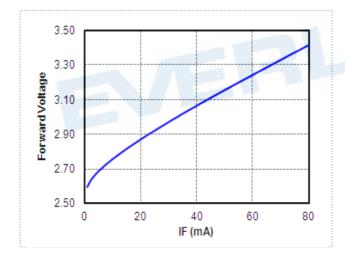


Typical Electro-Optical-Thermal Characteristics Curves

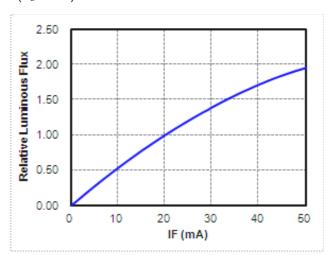
1. Spectrum Distribution Current (T_a=25°C, I_F=20mA)



3. Relative Forward Voltage vs. Forward Current $(T_a=25^{\circ}C)$

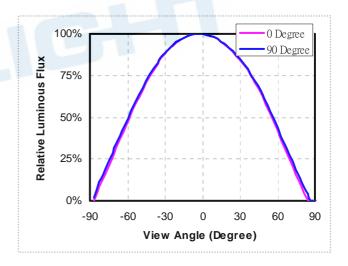


2. Relative Luminous Intensity vs. Forward $(T_a=25^{\circ}C)$



4. Radiation Diagram

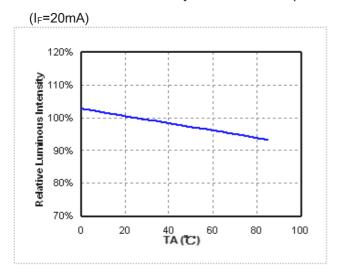
 $(T_a=25^{\circ}C, I_F=20mA)$



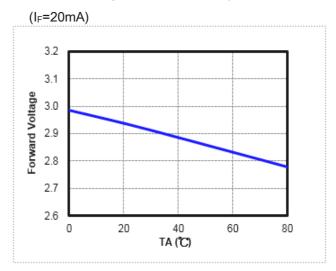


Typical Electro-Optical-Thermal Characteristics Curves

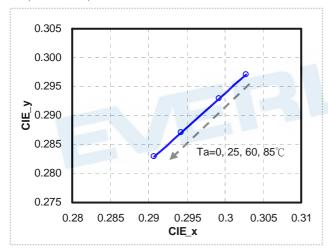
5. Relative Luminous Intensity vs. Ambient Temperature

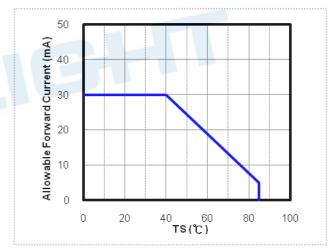


6. Forward Voltage vs. Ambient Temperature



7. Chromaticity Coordinates vs. Ambient Temperature 8. Forward Current De-rating Curve (I_F=20mA)



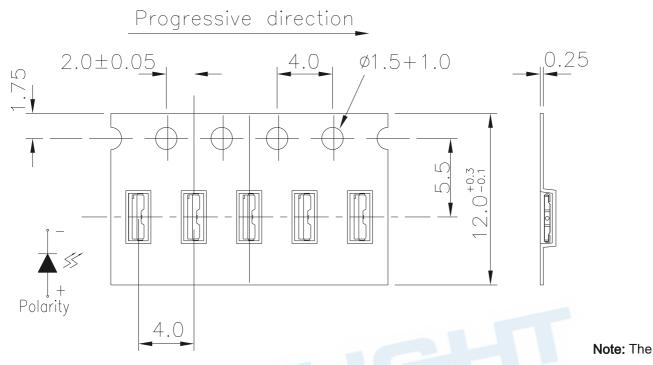


Issue No: DSE-0018145



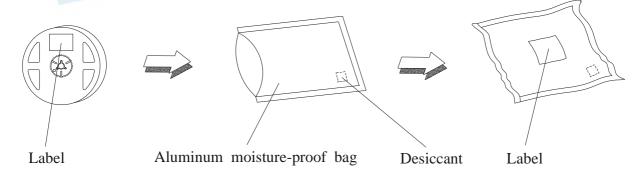
Carrier Tape Dimensions:

Loaded Quantity 1000/2000/3000/4000 pcs. Per Reel



tolerances unless mentioned is ± 0.1 mm, Unit = mm.

Moisture Resistant Packaging



Note: Actual photo of standard packing bag

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Moisture Resistant Packing Materials

Label Explanation

· CAT: Luminous Flux Rank

· HUE: Chromaticity Coordinates/Peak Wavelength

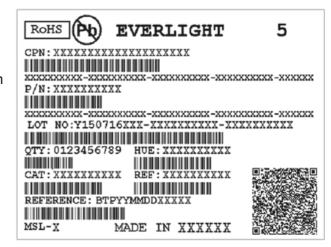
· CPN: Customer's Product Number

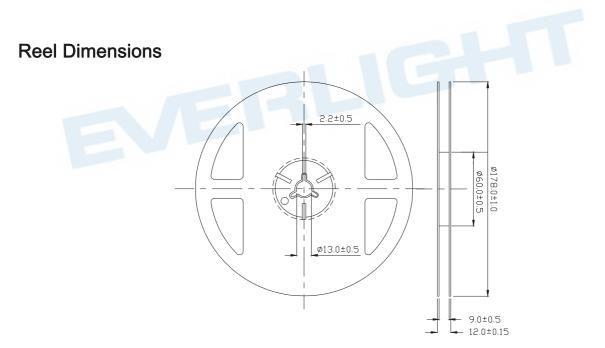
· P/N: Product Number

QTY: Packing Quantity

· LOT No: Lot Number

REF: Forward Voltage Rank





Note: The tolerances unless dimension are \pm 0.1mm.

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Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

		Test Conditio	Test	Criteria		
NO	Item -	Temp./ Humidity	I _F (mA)	Hours / Times	Iv @ 20mA	V _F @ 20mA
1	Reflow Soldering	Temp. : 260°C/10sed	C	2 times	<±10%	<±10%
2	Temperature cycle		00°C 30min.	200 cycles		
3	Thermal Shock	-10°C ~ 1 20min. (<15sec.)	00°C 20min.	200 cycles	-	
4	Low Temp. Storage	Ta= -40°C		1000 hrs		
5	High Temp. Storage	Ta= 100°C		1000 hrs		
6	Temp. Humidity Storage	Ta= 60°C/ 90%RH		1000 hrs	F.	700/
7	Steady State Operating Life of Low Temp.	Ta= -40°C	20	1000 hrs	VF <	70%, 110%,
8	Steady State Operating Life Condition 1	Ta= 25°C/ Room Humidity	20	1000 hrs		
9	Steady State Operating Life Condition 2	Ta= 60°C	20	1000 hrs		
10	Steady State Operating Life of High Temp.	Ta= 85°C	5	1000 hrs	-	
11	Steady State Operating Life of High Humidity Heat	Ta= 60°C/ 90%RH	20	1000 hrs	•	

Notes:

^{1.} Sampling for each test item: 22 (pcs.)

^{2.} Measurements are performed after allowing the LEDs to return to room temperature.



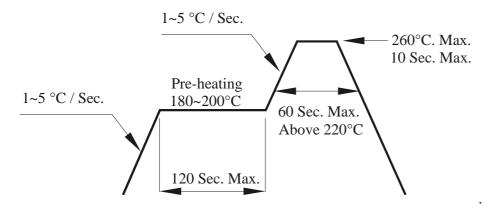
Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be used within one year and kept at 30°C or less and 70%RH or less.
- 2.3 After opening the package: We recommend that the LED should be soldered quickly (within 3 days). The soldering condition is 30°C or less and 60%RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours. (One time only)
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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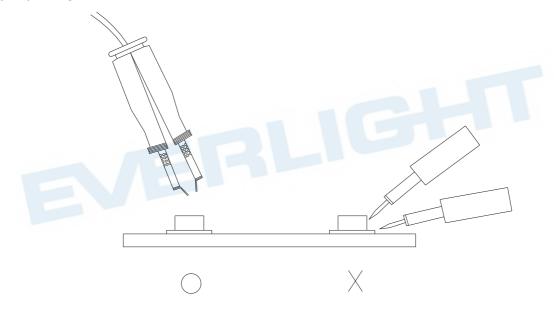


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.

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